



### **General Description**

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

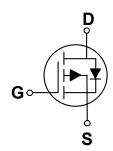
BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub>
-30 V	90 mΩ	-3.3 A

### **Features**

- -30V, -3.3A,  $R_{DS(ON)} \le 90 m\Omega @V_{GS} = -10V$
- · Fast switching
- · Green Device Available
- Suit for -4.5V Gate Drive Applications

#### SOT-23 Pin Configuration





#### **Applications**

- Notebook
- · Load Switch
- · Battery Protection
- · Hand-Held Instruments

Absolute Maximum Ratings T <sub>c</sub> =25°C unless otherwise noted						
Symbol	Parameter	Rating	Units			
$V_{DS}$	Drain-Source Voltage	-30	V			
$V_{GS}$	Gate-Source Voltage	±20	V			
I-	Drain Current - Continuous (T <sub>A</sub> =25°C)	-3.3	Α			
I <sub>D</sub>	Drain Current - Continuous (T <sub>A</sub> =70°C)	-2.64	Α			
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	-13.2	Α			
$P_D$	Power Dissipation (T <sub>A</sub> =25°C)	1.56	W			
' D	Power Dissipation - Derate above 25°C	0.012	W/°C			
$T_J$	Operating Junction Temperature Range	-50 to 150	°C			
T <sub>STG</sub>	Storage Temperature Range	-50 to 150	°C			
Marking Code		E、H				

Thermal Characteristics					
Symbol	Parameter	Тур.	Max	Unit	
$R_{ heta JA}$	Thermal Resistance Junction to Ambient		80	°C/W	





### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V , I <sub>D</sub> = -250uA	-30			V
I <sub>DSS</sub>	IDrain-Source Leakage Current	$V_{DS}$ = -30V , $V_{GS}$ = 0V , $T_{J}$ =25°C			-1	uA
		$V_{DS}$ = -24V , $V_{GS}$ = 0V , $T_{J}$ =125°C			-10	uA
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}$ = ±20V , $V_{DS}$ = 0V			±100	nA

#### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ = -10V , $I_D$ = -3A		75	90	mΩ
		$V_{GS}$ = -4.5V , $I_D$ = -2A		110	140	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=-250uA$	-1.2	-1.6	-2.2	V
gfs	Forward Transconductance	$V_{DS}$ = -10V , $I_{D}$ = -1A		3		S

#### **Dynamic and switching Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$Q_g$	Total Gate Charge (NOTE 2 \cdot 3)	V = 24V V = 4.5V		2.5	5	
$Q_{gs}$	Gate-Source Charge (NOTE 2 \cdot 3)	V <sub>DS</sub> = -24V , V <sub>GS</sub> = -4.5V , I <sub>D</sub> = -2A		0.1	0.3	nC
$Q_{gd}$	Gate-Drain Charge (NOTE 2 · 3)	102/\(\)		1.8	3.6	
$T_{d(on)}$	Turn-On Delay Time (NOTE 2 \ 3)			6.1	12	
T <sub>r</sub>	Rise Time (NOTE 2 \cdot 3)	$V_{DD}$ = -15V , $V_{GS}$ = -10V , $R_G$ = 6 $\Omega$ , $I_D$ = -1A		8.7	17	ns
$T_{d(off)}$	Turn-Off Delay Time (NOTE 2 · 3)			33.2	66	115
$T_f$	Fall Time (NOTE 2 \cdot 3)			3.7	7	
C <sub>iss</sub>	Input Capacitance			226	450	
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = -15V , $V_{GS}$ = 0V , F= 1MHz		39	78	pF
$C_{rss}$	Reverse Transfer Capacitance			29	58	

#### **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> = V <sub>D</sub> = 0V,Force Current			-3.3	Α
I <sub>SM</sub>	Pulsed Source Current				-6.6	Α
$V_{SD}$	Diode Forward Voltage	$V_{GS}$ = 0V , $I_{S}$ = -1A , $T_{J}$ = 25 $^{\circ}$ C			-1	V

#### NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- ${\it 3. Essentially independent of operating temperature.}\\$





#### **Characteristics Curves**

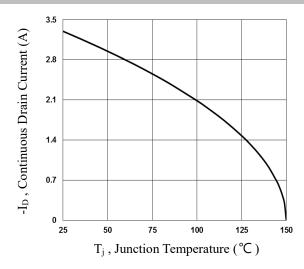


Fig.1 Continuous Drain Current vs. Tc

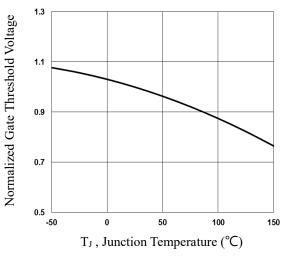


Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>

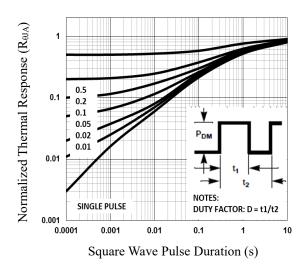


Fig.5 Normalized Transient Impedance

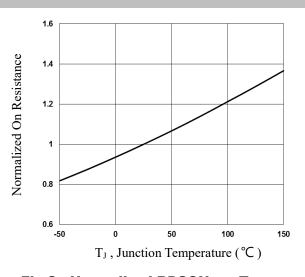


Fig.2 Normalized RDSON vs. TJ

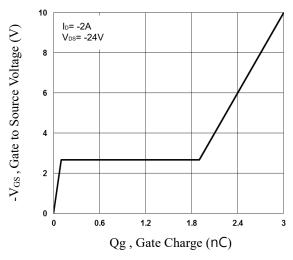


Fig.4 Gate Charge Waveform

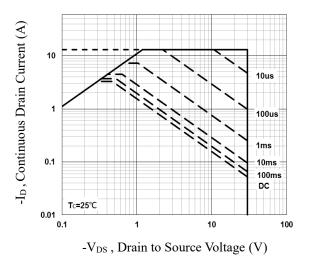
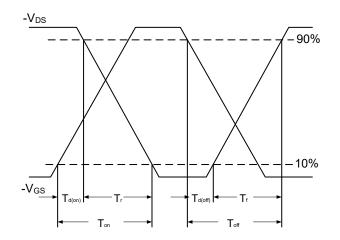


Fig.6 Maximum Safe Operation Area





#### **Characteristics Curves**



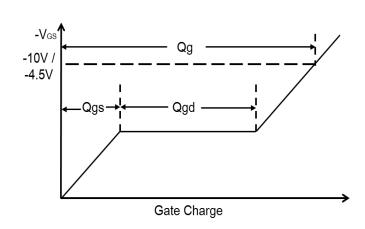
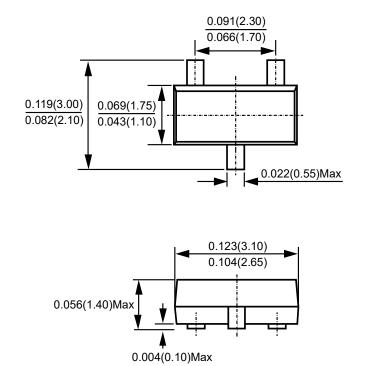
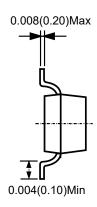


Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

### **Package Outline Dimensions**





**SOT-23** Dimensions in inches and (millimeters)





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